General Features

- High Performance, Low Power AVR® 8-Bit Microcontroller
- Advanced RISC Architecture
 - 131 Powerful Instructions Most Single Clock Cycle Execution
 - 32 x 8 General Purpose Working Registers
 - Up to 16MIPS Throughput at 16Mhz
 - On-chip 2-cycle Multiplier
- · Non-volatile Program and Data Memories
 - 64K Bytes of In-System Self-Programmable Flash
 - Endurance: 10,000 Write/Erase Cycles
 - 4K Bytes EEPROM
 - Contains 128 Bytes of One Time Programmable Memory
 - Endurance: 100,000 Write/Erase Cycles
 - 4K Bytes Internal SRAM
 - Optional Boot Code Section
 - In-System Programming by On-chip Bootloader program
- · JTAG (IEEE std. 1149.1 compliant) Interface
 - Boundary-scan Capabilities According to the JTAG Standard
 - Extensive On-chip Debug Support
 - Programming of Flash, EEPROM, Fuses, and Locks Bits through JTAG Interface
 - Locking JTAG for Software Security (using OTP programmation)
- ISO7816 UART Interface Fully compliant with EMV, GIE-CB and WHQL Standards
 - Programmable ISO clock from 1 Mhz to 4.8, 6, 8 or 12Mhz
 - Card insertion/removal detection with automatic deactivation sequence
 - Programmable Baud Rate Generator from 372 to 3 clock cycles
 - Synchronous/Asynchronous Protocols T=0 and T=1 with Direct of Inverse Convention
 - Automatic character repetition on parity errors
 - 32 Bit Waiting Time Counter
 - 16 Bit Guard Time Counter/Block Guard Time Counter
 - Internal Step Up/Down Converter with Programmable Voltage Output if DC/DC embedded:
 - Class A: 5V +/-8% at 60mA, Vcc>2.85 (50mA if Vcc >2.7)
 - Class B: 3V +/-8% at 60mA, Vcc>2.85 (50mA if Vcc >2.7)
 - Class C: 1.8V +/-8% at 35mA
 - ISO7816-12 USB Host controller for card interface
 - Supports up to 60mA USB Smart Cards
 - Supports limited cable length to Smart Card Connector (~50cm)
 - 4 kV ESD (MIL/STD 833 Class 3) protection on whole Smart Card Interface
- USB 2.0 Full-speed Device Module
 - Complies fully with:
 - Universal Serial Bus Specification Rev 2.0
 - Supports data transfer rates up to 12 Mbit/s
 - Endpoint 0 for Control Transfers : up to 64-bytes
 - 8 Programmable Endpoints with IN or OUT Directions and with Bulk, Interrupt or Isochronous Transfers
 - 3 Programmable Endpoints with double buffering of 64x2 bytes
 - Suspend/Resume Interrupts, and Remote Wake-up Support
 - Power-on Reset and USB Bus Reset



8-bit **AVR**® Microcontroller for Smart Card Readers

AT90SCR100

Summary Preliminary

6568AX-SMS-23Oct08





- 48 Mhz clock for Full-speed Bus Operation
- USB Bus Disconnection on Microcontroller Request
- Peripheral Features
 - One 8-bit Timer/Counters with Separate Prescaler, Compare Mode and PWM Channel
 - One 8-bit Timer/Counters with Separate Prescaler, Compare Mode and Real Time Counter on Separate Oscillator
 - One 16-bit Timer/Counters with Separate Prescaler and Compare Mode
 - Hardware Watchdog
 - Hardware AES 128/256 Engine
 - Random Number Generator (RNG)
- Communication Peripherals
 - High Speed Master/Slave SPI Serial Interface (Up to 20Mhz)
 - 2-Wire Serial Interface
 - USART interface (up to 2Mbps)
 - Standard SPI Interface (to ease the communication with most of RF front end chip)
- Special Microcontroller Feature
 - Power-on Reset and Brown-out Detection
 - Internal Callibrated Oscillator
 - External and Internal Interrupt Sources
 - Five Sleep Modes: Idle, Power-save, Power-down, Standby and Extended Standby
 - Supply Monitoring with Interruption Generation below a fixed level.
- Keyboard Interface with up to 5x4 Matrix Management Capability + Interrupts and Wake-Up on Key Pressed Event
- Up to 4 x I/O Ports: Programmable I/O Port
- Up to 4 x LED Outputs with Programmable Current Sources: 2 or 4 mA (not usable in emulation mode)
- Specific and Unique Serial Number per IC in production.
- · Operating Temperature
 - Industrial (-40°C to +85°C)
- Core Operating Voltages
 - 2.4 5.5V
- DC/DC Operating Voltages (See "Smart Card Interface Characteristics" for details)
 - 2.7 5.5V
- Maximum Frequency
 - 8Mhz Clock Input

1. Description

Smart Cards and Smart Card Readers are increasingly being used in various systems such as Health Care, USB Token, Password Generator, Access control, Laptop Computer, Set Topbox, Payment Terminals... These applications require complex integration using different communicating interfaces.

The AT90SCR100 based on the powerful 8/16bit AVR® Core technology, meets the requirements of such applications thanks to its embedded communication interfaces: USB Full-speed, ISO7816 (1-4,12) interface, High Speed SPI supporting speed up to 20Mbps, USART, TWI.

The AT90SCR100 has been designed to support standard systems such as Contactless interface and Fingerchip, among others.

An AES engine is also embedded to ease the development of secured communication between AT90SCR100 and external peripherals.

All these features require a minimum of external components which makes this solution the best choice for low cost high integration in small environments.

Its FLASH memory allows remote firmware management. The JTAG interface eases code development, and program loading in end-customers factories.

A low pincount package is also available for embedded application with size constraints, such as USB tokens, laptop computers.

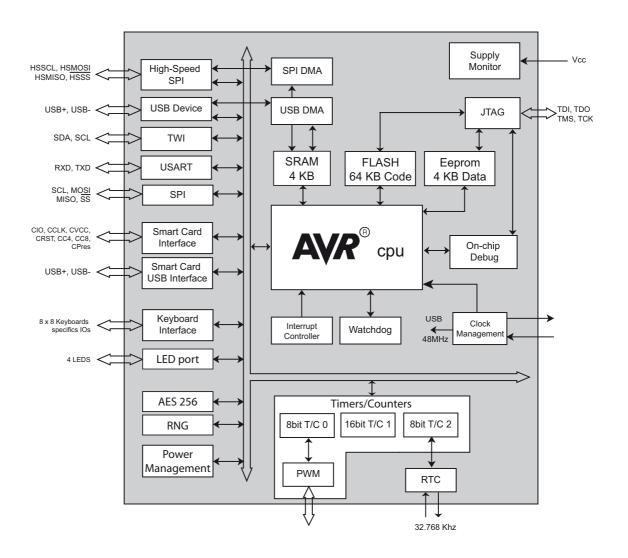
A complete datasheet will soon be available on Atmel's website: www.atmel.com.





2. Block Diagram

Figure 2-1. Block Diagram



3. Pin List Configuration

- · 2 package configurations to answer different needs
 - 32pins: LowPinCount package: for small package size, useful for small embedded systems (AT90SCR100L and AT90SCR100LS)
 - 64pins: FullPinCount: For full performance advanced reader (AT90SCR100H)



On Full Pin Count (FPC) package, the only supported package type is QFN, and we connect all the Vss signals to the e-pad. It is important to have it fully soldered on groundplane of final PCB.



- USBReg refers to 3.3V USB specific regulator
- PCINTx refer to Pin Change Interrupts. See "External Interrupt Registers" in full Datasheet.



Take care of the multiplexed functionnalities of each port. All functionnalities may be active at the same time. The only way to disable a feature is to deactive it inside the corresponding peripheral blokck.

 Table 3-1.
 Pin List Configuration

Portmap	ID	SCR100L	SCR100LS	SCR100H	Supply		Configuration, Role
	Vcc	x	x	х		Vcc	Voltage Supply
	Vss	x	x	e ⁽¹⁾		Vss	Ground
	AVss	x	x	e ⁽¹⁾		AVss	PLL Ground
	RST	х	x	x	Vcc	RST	Reset signal: Drive low to reinitialize the chip
oins	Xtal1	х	x	х		XTAL1	Olas I Israel Ourseld on to OMIs arists I
ric p	Xtal2	х	x	х		XTAL2	Clock Input: Support up to 8 Mhz cristals
gene	DVcc	x	x	х		DVcc	Digital Vcc:Used for internal regulator decoupling
Unmapped, generic pins	Vcc2	x	x	x		Vcc2	Voltage Supply: To be tied to same Vcc supply voltage
ларр	Vcc3		-	x		Vcc3	Voltage Supply: To be tied to same Vcc supply voltage
Unn	Vcc4		-	x		Vcc4	Voltage Supply: To be tied to same Vcc supply voltage
	Vcc5	,		х	-	Vcc5	Voltage Supply: To be tied to same Vcc supply voltage
	Vdcdc	x	x	x		Vdcdc	Voltage Supply for DC/DC Converter.
	Vss2	х	x	e ⁽¹⁾		Vss2	Second Vss: To be tied to Vss
	Vss3	x	x	e ⁽¹⁾		Vss3	Third Vss: To be tied to Vss
	D+	х	X	х	USB	D+	USB Interface
	D-	X	X	х	Reg	D-	
	UCap	X	X	X		UCap	USB Decoupling: Used for specific USB regulator decoupling
	RTC1	-	-	х	Vcc	TOSC1	TOSCx: 32.768 Khz cristal input for Real Time Clock. (Please
	RTC2	-	-	х	VCC	TOSC2	note that these pins are not GPIO accessible).





Table 3-1. Pin List Configuration

Table 3-1.		P	'IN L	ist Co	nfigura	tion				
Portmap	ID	SCR100L	SCR100LS	SCR100H	Supply	Configuration, Role				
λΤΑ	PA7	-		х		KbIN7			PCINT7	
	PA6	-		х		KbIN6			PCINT6	
	PA5	-		х		KbIN5			PCINT5	
	PA4	-		х	Vcc	KbIN4			PCINT4	KblNx: Input for "Keyboard Interface"
PORT	PA3	-		х		KbIN3			PCINT3	
	PA2	-		х		KbIN2			PCINT2	
	PA1	•		х		KbIN1			PCINT1	
	PA0	-	-	x		KbIN0			PCINT0	
	DD7					001/	0004		DOINT45	
,	PB7	X	•	X	Vcc	SCK	OC2A		PCINT15	SS, MISO, MOSI, SCK: Standard "SPI - Serial Peripheral Interface" OCxx: Output Comparator outputs. See "Timers". ICP1: Input Capture. See "16-bit Timer/Counter1 with PWM" PWM: Output from "8-bit Timer/Counter0 with PWM" Tx: Clock input for "Timers" 0 and 1
,	PB6	х	•	X		MISO	OC2B		PCINT14	
В	PB5	X	•	X		MOSI	OC1A		PCINT13	
PORT B	PB4 PB3	X	-	X		SS	OC0B OC0A		PCINT12 PCINT11	
P	PB2	-		X		PVVIVI	ICP1			XCK: Clock input for synchronous "USART"
		•	-	X		INITO		СКО	PCINT10	INTx: "External Interrupts", default configuration
	PB1 PB0	-	-	X		INT3	T1 T0	XCK	PCINT9 PCINT8	CKO : System clock output. (only active if CKOUT fuse is enabled). "Fuse Low Byte".
	FB0	-	-	X		INTZ	10	XCK	PCIN18	
	PC5	-		х	Vcc	JTGTDI	LED3			
(PC4	-		х		JTGTDO	LED2			JTGxxx: "JTAG Interface and On-chip Debug System"
r C ⁽³	PC3	-		х		JTGTMS	LED1			SDA, SCL: "2-wire Serial Interface _ TWI" signals
PORT C ⁽³⁾	PC2	х	х	х		JTGTCK	LED0			LEDx: "LED" Outputs (IO driving current) INTxb: "External Interrupts", bis configuration
"	PC1	-	-	х		SDA	INT3b			, ,
	PC0	-	-	x		SCL	INT2b			
	DD7		3.5			Hemico			DCINTOS	
	PD7	-	X	X	Vcc	HSMISO			PCINT23	
	PD6	-	X	X		HSMOSI			PCINT22	However, filling Conned CDI Controlled (AUCC MCC)
٥	PD5 PD4	-	X	X		HSSCK			PCINT20	HSxxxx: "High-Speed SPI Controller" (MISO, MOSI, SCK, SS)
PORT D		-	X	X		HSSS			PCINT20 PCINT19	INTx: "External Interrupts", default configuration
Ğ	PD3	-	-	X		INT1	OC1B			TXD, RXD: "USART" signals OCxB: Output Comparators: See "Timers".
	PD2 PD1	-	-	X		TXD	OCIB		PCINT18 PCINT17	OOAB. Output Comparators. Gee Timers .
	PD1	X	X	X		RXD			PCINT17 PCINT16	
	FDU	X	X	X		KYD			FCINT 10	

 Table 3-1.
 Pin List Configuration

Portmap	ID	SCR100L	SCR100LS	SCR100H	KiddnS	Configuration, Role				
	PE7	,	-	x	Vcc	KbO7			PCINT31	
	PE6		-	х		KbO6			PCINT30	
	PE5	-	-	х		KbO5			PCINT29	
Ε	PE4	1	-	х		KbO4			PCINT28	
PORT E	PE3	-	-	х		KbO3			PCINT27	KbOx: Output for "Keyboard Interface"
	PE2	1	-	х		KbO2			PCINT26	
	PE1	-	-	х		KbO1			PCINT25	
	PE0		-	x		KbO0			PCINT24	
		x	x	x	Vcc	CPRES				
	Smart Card PORT	x	x	x	CVcc	CCLK				
		x	x	x		CRST				Cx: "Smart Card Interface Block (SCIB)": Standard ISO7816 port and "USB Host Controller".
		x	x	x		CIO				
		x	x	x	(2)	CC4, DP				
		x	x	x		CC8, DM				
		х	x	x	CVcc	CVcc				
		х	х	x		CVSense				
		х	х	e ⁽¹⁾		CVss				Smart Card Interface: "DC/DC Converter" Supply Signals
		x	x	х		LI				
		x	x	х		LO				

Notes: 1. Should be connected to e-pad underneath QFN package

- 2. According to the current configuration, these pins are supplied either by USB regulator or CVcc
- 3. PORT C is not complete, due to RTC pins, dedicated to oscillator pads





3.1 Typical Application

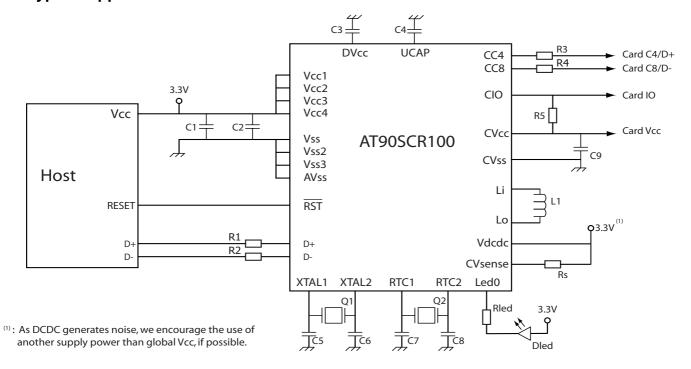


Table 3-2. External Components, Bill Of Materials

	External componente, Bill of Materials								
Reference	Description	Value	Comment						
R1, R2 R3, R4	USB Pad Serial Resistor	22Ω +/-10%	-						
R5	CIO Pull-up Resistor	10ΚΩ +/-10%	(Optional) Can be required for high speed communication						
Rs	DCDC Sense Resistor	200mΩ +/-2% 125mW	Current Sensing: Overcurrent detection						
C1	Power Supply Decoupling capacitor	4.7µF +/-10%	Maximum application capacitance allowed by USB standard is 10μF						
C2	Power Supply Filter capacitor	100nF	-						
C3	Internal Core Regulator Decoupling capacitor	2.2µF +/-10%	Used for internal regulator stability						
C4	Internal USB Regulator Decoupling capacitor	2.2µF +/-10%	Used for internal regulator stability						
C5, C6	PLL Filter capacitors	47pF +/-10%	-						
C7, C8	RTC Filter capacitors	22pF +/-10%	Only if Real Time Counter is used.						
C9	DCDC Decoupling Capacitor	10μF +/-10% esr=100mΩ	Tantalum capacitor is needed Recommended: AVX: TPSE106-035-200						
L1	DCDC inductance	6.8μH esr=20.2mΩ	Recommended: Gowanda: SMP3316LP-681M						
Q1	Crystal	8.0 Mhz							
Q2	Real Time Crystal	3.768 Mhz	Only if Real Time Counter is used						
Rled/Dled	LED mechanism		Depends on the configuration of the Led Controller						

3.1.1 Recommendations

- 1. In Order to reduce the board parasitics, the external components for DCDC converter should be as close as possible to the chip pins (ideally solded directly on the pins).
- 2. In order to have a correct current limitation, the board parasitic resistances must be taken into account in the choice of the Rs value (e.g., if each metal line connecting Rs to the chip adds a 10 m Ω resistance, the correct Rs value should be 200-2x10=180m Ω)
- 3. CVcc and CVss lines must have very low resistance (short and wide metal line).
- 4. R1, R2, R3 and R4 must be placed as close as possible to the chip pins.
- 5. Connect e-pad to ground. If possible connect it to ground plane





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